



Legislation Details (With Text)

File #: 05418 **Version:** 1 **Name:** Approving plans and specifications and authorizing the Board of Public Works to advertise and receive bids for Chip Sealing 2007 - District 3, Contract No. 6009.

Type: Resolution **Status:** Passed

File created: 1/11/2007 **In control:** BOARD OF PUBLIC WORKS

On agenda: 2/6/2007 **Final action:** 2/6/2007

Enactment date: 2/7/2007 **Enactment #:** RES-07-00185

Title: Approving plans and specifications and authorizing the Board of Public Works to advertise and receive bids for Chip Sealing 2007 - District 3, Contract No. 6009. (3rd AD)

Sponsors: Common Council By Request

Indexes:

Code sections:

Attachments:

Date	Ver.	Action By	Action	Result
2/6/2007	1	COMMON COUNCIL	Adopt	Pass
1/17/2007	1	BOARD OF PUBLIC WORKS	RECOMMEND TO COUNCIL TO ADOPT - REPORT OF OFFICER	Pass
1/12/2007	1	Finance Dept/Approval Group	Approved Fiscal Note By The Comptroller's Office	
1/11/2007	1	Engineering Division	Fiscal Note Required / Approval	

Fiscal Note

Estimated Cost is \$120,000. Funds available in CS53-54472-810358-00-53W0430

Title

Approving plans and specifications and authorizing the Board of Public Works to advertise and receive bids for Chip Sealing 2007 - District 3, Contract No. 6009. (3rd AD)

Body

PREAMBLE

The roadways within the City of Madison's infrastructure are a considerable investment. Proper maintenance of pavements helps extend the useful life of a pavement. Pavements left in disrepair deteriorate and require resurfacing sooner than pavements, which have preventative maintenance.

Chip Sealing extends the pavements useful life. Chip Sealing helps keep the underlying base dry providing better support for vehicle loading.

NOW THEREFORE BE IT RESOLVED that the plans and specifications for Chip Sealing 2007 - District 3 are hereby approved, and

BE IT FURTHER RESOLVED that the Board of Public Works be and is hereby authorized to advertise and receive bids for said project.